SDAS229A - APRIL 1982 - REVISED JANUARY 1995

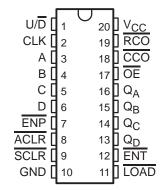
- 3-State Q Outputs Drive Bus Lines Directly
- Counter Operation Independent of 3-State Output
- Fully Synchronous Clear, Count, and Load
- Asynchronous Clear Is Also Provided
- Fully Cascadable
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

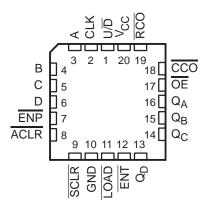
The SN74ALS568A decade counter and 'ALS569A binary counters are programmable, count up or down, and offer both synchronous and asynchronous clearing. All synchronous functions are executed on the positive-going edge of the clock (CLK) input.

The clear function is initiated by applying a low level to either asynchronous clear (\overline{ACLR}) or synchronous clear (\overline{SCLR}). Asynchronous (direct) clearing overrides all other functions of the device, while synchronous clearing overrides only the other synchronous functions. Data is loaded from the A, B, C, and D inputs by holding load (\overline{LOAD}) low during a positive-going clock transition. The counting function is enabled only when enable P (\overline{ENP}) and enable T (\overline{ENT}) are low and \overline{ACLR} , \overline{SCLR} , and \overline{LOAD} are high. The up/down (U/ \overline{D}) input controls the direction of the count. These counters count up when U/ \overline{D} is high and count down when U/ \overline{D} is low.

SN54ALS569A . . . J PACKAGE SN74ALS568A, SN74ALS569A . . . DW OR N PACKAGE (TOP VIEW)



SN54ALS569A . . . FK PACKAGE (TOP VIEW)



A high level at the output-enable (\overline{OE}) input forces the Q outputs into the high-impedance state, and a low level enables those outputs. Counting is independent of \overline{OE} . \overline{ENT} is fed forward to enable the ripple-carry output (\overline{RCO}) to produce a low-level pulse while the count is zero (all Q outputs low) when counting down or maximum (9 or 15) when counting up. The clocked carry output (\overline{CCO}) produces a low-level pulse for a duration equal to that of the low level of the clock when \overline{RCO} is low and the counter is enabled (both \overline{ENP} and \overline{ENT} are low); otherwise, \overline{CCO} is high. \overline{CCO} does not have the glitches commonly associated with a ripple-carry output. Cascading is normally accomplished by connecting \overline{RCO} or \overline{CCO} of the first counter to \overline{ENT} of the next counter. However, for very high-speed counting, \overline{RCO} should be used for cascading since \overline{CCO} does not become active until the clock returns to the low level.

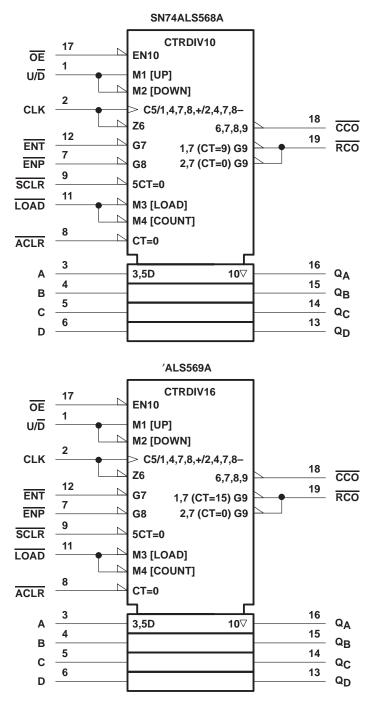
The SN54ALS569A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS568A and SN74ALS569A are characterized for operation from 0°C to 70°C.

SN54ALS569A, SN74ALS568A, SN74ALS569A SYNCHRONOUS 4-BIT UP/DOWN DECADE AND BINARY COUNTERS WITH 3-STATE OUTPUTS SDAS229A - APRIL 1982 - REVISED JANUARY 1995

FUNCTION TABLE

	•	•	INPU	TS				ODED ATION
OE	DE ACLR SCLR LO			DAD ENT EN		U/D	CLK	OPERATION
Н	Х	Х	Х	Χ	Χ	Χ	Χ	Q outputs disabled
L	L	X	Χ	X	X	Χ	Χ	Asynchronous clear
L	Н	L	Χ	Χ	X	Χ	\uparrow	Synchronous clear
L	Н	Н	L	Χ	X	Χ	\uparrow	Load
L	Н	Н	Н	L	L	Н	\uparrow	Count up
L	Н	Н	Н	L	L	L	\uparrow	Count down
L	Н	Н	Н	Н	Χ	Χ	Χ	Inhibit count
L	Н	Н	Н	Χ	Н	Χ	Χ	Inhibit count

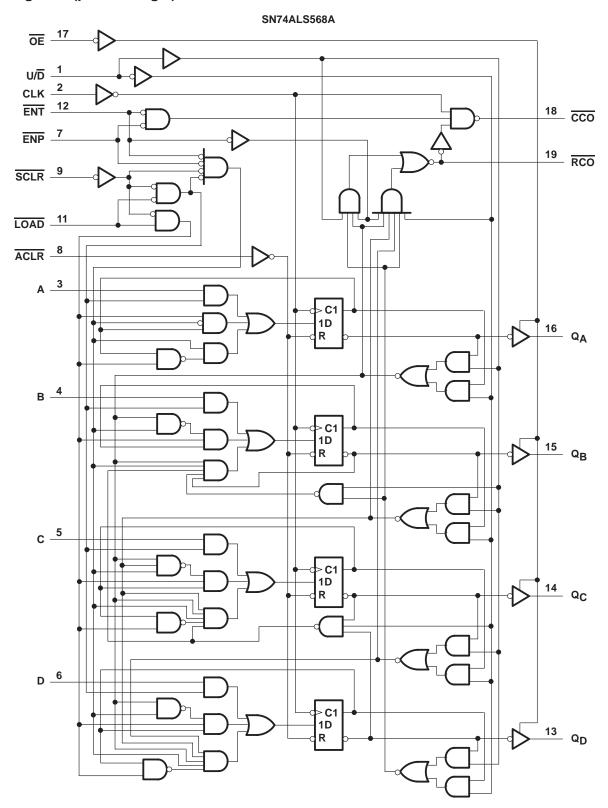
logic symbols†



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

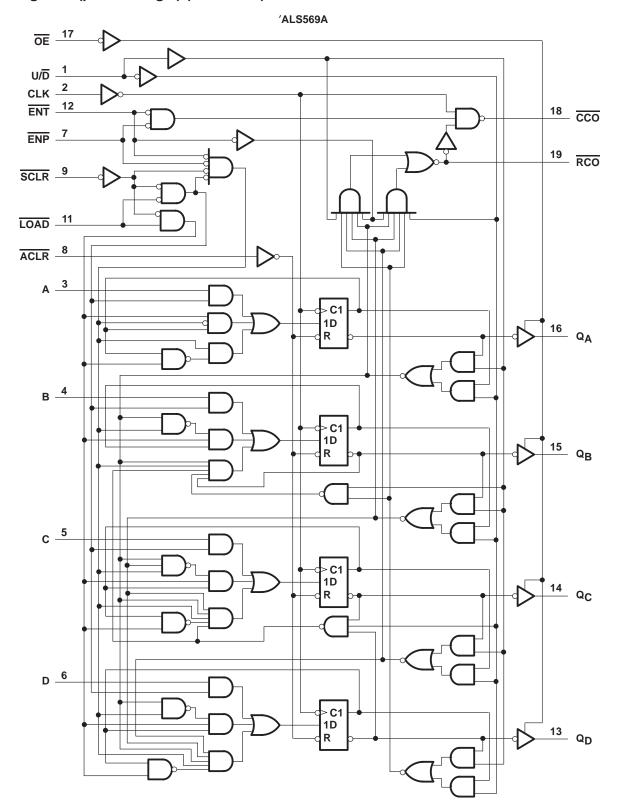
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logic diagrams (positive logic)



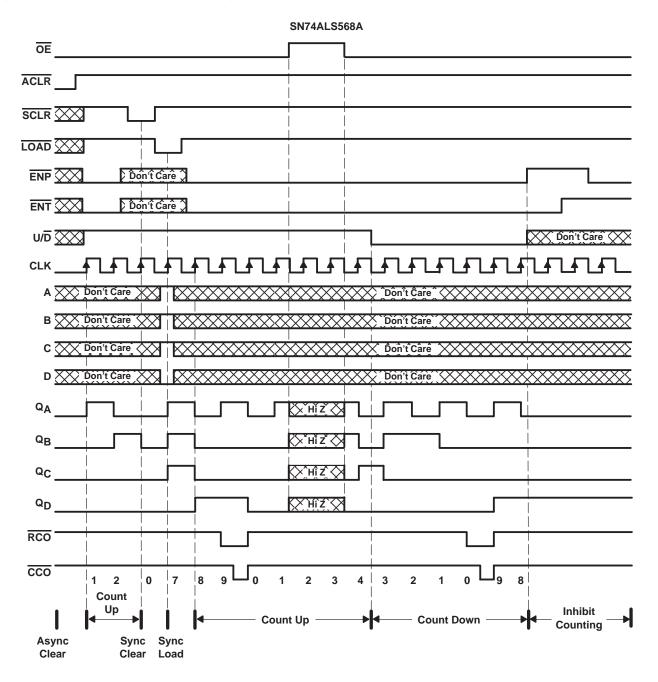


logic diagrams (positive logic) (continued)



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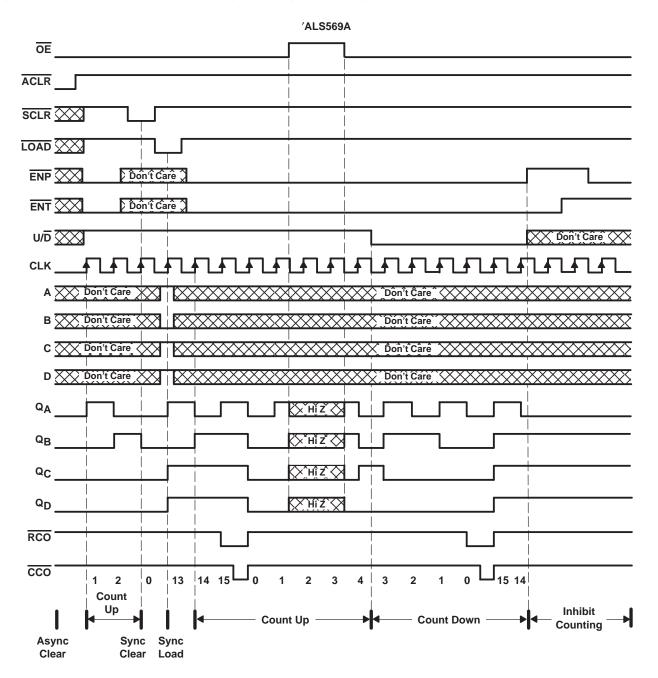
typical load, count, and inhibit sequences





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typical load, count, and inhibit sequences (continued)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T _A : SN54ALS569A	55°C to 125°C
SN74ALS568A, SN74ALS569A	0°C to 70°C
Storage temperature range	-65°C to 150°C

recommended operating conditions

				SN	54ALS56	9A		74ALS56 74ALS56		UNIT	
				MIN	NOM	MAX	MIN	NOM	MAX		
Vсс	Supply voltage			4.5	5	5.5	4.5	5	5.5	V	
V_{IH}	High-level input voltage			2			2			V	
V_{IL}	Low-level input voltage					0.7			0.8	V	
1	High-level output current	Q outputs				-1			-2.6	mA	
ІОН	nigh-level output current	CCO and RCO				-0.4			-0.4).4	
loi	Low-level output current	Q outputs				12			24	mA	
lOL	Low-level output current	CCO and RCO			4			8	mA		
٤	Clock fraguency	SN74ALS568A					0		20	MHz	
fclock	Clock frequency	'ALS569A		0		22	0		30	IVITZ	
		ACLR or LOAD low	,	20			15				
		SN74ALS568A	CLK high				25			ns	
t _W	Pulse duration	3N/4AL3300A	CLK low				25				
		'ALS569A	CLK high	20			16.5				
		ALSSOSA	CLK low	23			16.5				
		Data at A, B, C, D		25			20				
		END ENE	High	35			30				
		ENP, ENT	Low	25			20				
		SCLR	Low	20			15				
t _{su}	Setup time before CLK↑	SCLR	High (inactive)	35			30			ns	
		LOAD	Low	20			15				
		LOAD	High (inactive)	35			30				
		U/D	35			30					
		ACLR inactive		10			10				
th	Hold time after CLK↑ for a	ny input		0			0			ns	
TA	Operating free-air tempera	ture		-55		125	0		70	°C	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CON	IDITIONS	SNS	54ALS56	9A	SN7 SN7	UNIT			
				MIN	TYP [†]	MAX	MIN	TYP [†]	MAX		
VIK		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.5			-1.5	V	
	All outputs	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2			
VOH	Q outputs	V _{CC} = 4.5 V	$I_{OH} = -1 \text{ mA}$	2.4	3.3					V	
	Q outputs	vCC = 4.5 v	$I_{OH} = -2.6 \text{ mA}$				2.4	3.2			
	Q outputs	V _{CC} = 4.5 V	I _{OL} = 12 mA		0.25	0.4		0.25	0.4		
1/0	Q outputs	VCC = 4.5 V	$I_{OL} = 24 \text{ mA}$					0.35	0.5	V	
VOL	CCO and RCO	V _{CC} = 4.5 V	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	ľ	
	CCO and RCO	VCC = 4.5 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5		
lozh		$V_{CC} = 5.5 \text{ V},$	V _O = 2.7 V			20			20	μΑ	
lozL		V _{CC} = 5.5 V,	V _O = 0.4 V			-20			-20	μΑ	
lį		V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA	
lн		$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20			20	μΑ	
I _{IL}		$V_{CC} = 5.5 \text{ V},$	V _I = 0.4 V			-0.2			-0.2	mA	
. +	CCO and RCO	., 551	\\ 0.05\\	-15		-70	-15		-70		
10 [‡]	Q outputs	V _{CC} = 5.5 V,	$V_0 = 2.25 \text{ V}$	-20		-112	-30		-112	mA	
	-		Outputs high		16	26		16	26		
ICC		V _{CC} = 5.5 V	Outputs low		20	32		20	32	mA	
			Outputs disabled		20	32		20	32		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

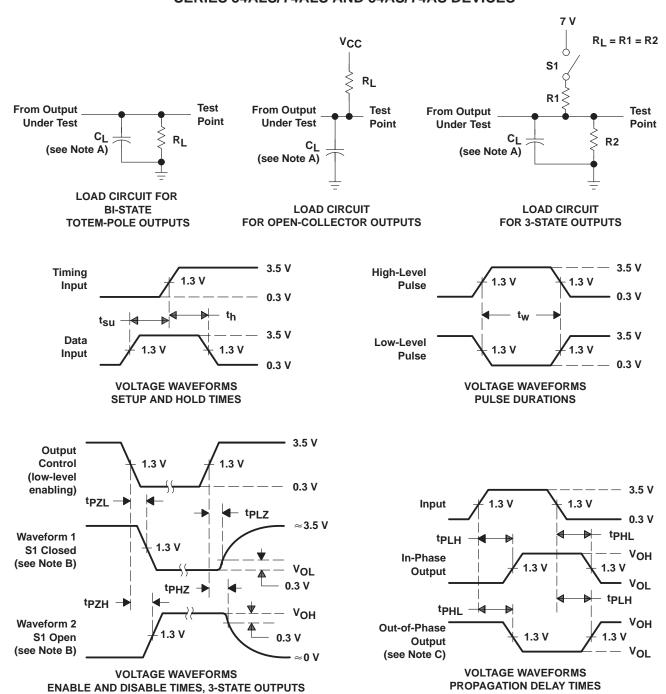
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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _l R1 R2	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω , R2 = 500 Ω , T_A = MIN to MAX †					
	((001101)	SN54AL	S569A	SN74AL SN74AL				
			MIN	MAX	MIN	MAX			
f _{max}	SN74AI	LS568A			20		MHz		
max	'ALS	569A	22		30		IVII IZ		
^t PLH	CLK	Any O	4	21	4	13	ns		
^t PHL	OLK	Any Q	7	19	7	16	113		
^t PLH	CLK	RCO	12	37	12	28	ns		
^t PHL	OEK	RCO	10	28	10	19	113		
^t PLH	CLK	cco	5	17	5	13	ns		
^t PHL	CLK	CCO	6	30	6	25			
^t PLH	U/ D	RCO	9	31	9	23	ns		
^t PHL	0/0	RCO	9	33	9	19	113		
^t PLH	ENT	RCO	6	21	6	15	ns		
^t PHL	LIVI	ROO	4	20	4	13			
^t PLH	ENT	cco	5	18	5	13	ns		
^t PHL	LIVI	000	9	32	9	23			
^t PLH	<u>ENP</u>	cco	4	18	4	12	ns		
^t PHL		000	5	18	5	14			
^t PHL	ACLR	Any Q	9	25	9	20	ns		
^t PZH	ŌĒ	Any Q	6	23	6	18	ns		
^t PZL	UE UE	Ally Q	6	29	6	24	119		
^t PHZ	ŌĒ	Any Q	1	12	1	10	ns		
^t PLZ		Any &	3	29	3	13	113		

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_{\Gamma} = t_{f} = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
83025022A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	83025022A SNJ54ALS 569AFK	Samples
8302502RA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8302502RA SNJ54ALS569AJ	Samples
SN54ALS569AJ	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS569AJ	Samples
SN74ALS569ADWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS569A	Samples
SN74ALS569AN	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS569AN	Samples
SNJ54ALS569AFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	83025022A SNJ54ALS 569AFK	Samples
SNJ54ALS569AJ	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	8302502RA SNJ54ALS569AJ	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

PACKAGE OPTION ADDENDUM

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54ALS569A, SN74ALS569A:

Catalog: SN74ALS569A

Military: SN54ALS569A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width					
В0	Dimension designed to accommodate the component length					
K0	O Dimension designed to accommodate the component thickness					
W	Overall width of the carrier tape					
P1	Pitch between successive cavity centers					

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS569ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
I	SN74ALS569ADWR	SOIC	DW	20	2000	367.0	367.0	45.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
83025022A	FK	LCCC	20	1	506.98	12.06	2030	NA
SN74ALS569AN	N	PDIP	20	20	506	13.97	11230	4.32
SNJ54ALS569AFK	FK	LCCC	20	1	506.98	12.06	2030	NA

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



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